

## Refine Search

### Search Results -

Term	Documents
HEAT	1083296
HEATS	69368
PRESSURE	1671917
PRESSURES	309040
SENSITIVE	508468
SENSITIVES	101
ADHESIVE	431933
ADHESIVES	131206
MICROSPHERE	10138
MICROSPHERES	28375
SURFACE	2620247
((((HEAT EXPAND\$ PRESSURE SENSITIVE ADHESIVE) AND (HEAT EXPAND\$ MICROSPHERE) AND (SURFACE RESTIVITY) AND (SURFACE ROUGHNESS) AND (ANTISTATIC OR CONDUCTIVE)).CLM.).PGPB,USPT.	0

There are more results than shown above. [Click here to view the entire set.](#)

**Database:**

US Pre-Grant Publication Full-Text Database  
 US Patents Full-Text Database  
 US OCR Full-Text Database  
 EPO Abstracts Database  
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 Derwent World Patents Index  
 IBM Technical Disclosure Bulletins

**Search:**

L2

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### Search History

**DATE:** Wednesday, July 06, 2005    [Printable Copy](#)    [Create Case](#)

Set  
Name   Query

Hit    Set  
Hit    Name

side by side		<u>Count</u>	result set
	<i>DB=PGPB,USPT; PLUR=YES; OP=ADJ</i>		
<u>L1</u>	(heat expand\$ pressure sensitive adhesive) and ((heat expand\$ microspheres) and (surface resistivity) and (surface roughness) and (antistatic or conductive)).CLM.	0	<u>L1</u>
<u>L2</u>	((heat expand\$ pressure sensitive adhesive) and (heat expand\$ microsphere) and (surface restivity) and (surface roughness) and (antistatic or conductive)).CLM.	0	<u>L2</u>

END OF SEARCH HISTORY